## DISCRETE SEMICONDUCTORS

## DATA SHEET

# **BF908WR**N-channel dual-gate MOS-FET

Preliminary specification
File under Discrete Semiconductors, SC07

1995 Apr 25

## **Philips Semiconductors**





## N-channel dual-gate MOS-FET

## BF908WR

#### **FEATURES**

- · High forward transfer admittance
- Short channel transistor with high forward transfer admittance to input capacitance ratio
- Low noise gain controlled amplifier up to 1 GHz.

### **APPLICATIONS**

• VHF and UHF applications with 12 V supply voltage, such as television tuners and professional communications equipment.

#### **DESCRIPTION**

Depletion type field effect transistor in a plastic microminiature SOT343R package. The transistor is protected against excessive input voltage surges by integrated back-to-back diodes between gates and source.

#### **CAUTION**

The device is supplied in an antistatic package. The gate-source input must be protected against static discharge during transport or handling.

#### **PINNING**

PIN	SYMBOL	DESCRIPTION
1	s, b	source
2	d	drain
3	<b>g</b> <sub>2</sub>	gate 2
4	<b>g</b> 1	gate 1

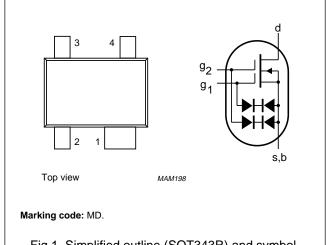


Fig.1 Simplified outline (SOT343R) and symbol.

## **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>DS</sub>	drain-source voltage		_	_	12	V
I <sub>D</sub>	drain current		_	_	40	mA
P <sub>tot</sub>	total power dissipation		_	_	300	mW
Tj	operating junction temperature		_	_	150	°C
y <sub>fs</sub>	forward transfer admittance		36	43	50	mS
C <sub>ig1-s</sub>	input capacitance at gate 1		2.4	3.1	4	pF
C <sub>rs</sub>	reverse transfer capacitance	f = 1 MHz	20	30	45	fF
F	noise figure	f = 800 MHz	_	1.5	2.5	dB

1995 Apr 25 2

## N-channel dual-gate MOS-FET

BF908WR

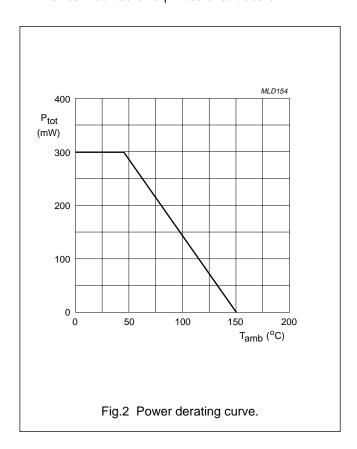
## **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>DS</sub>	drain-source voltage		_	12	V
I <sub>D</sub>	drain current		_	40	mA
I <sub>G1</sub>	gate 1 current		_	±10	mA
I <sub>G2</sub>	gate 2 current		_	±10	mA
P <sub>tot</sub>	total power dissipation	up to T <sub>amb</sub> = 45 °C; see Fig.2; note 1	_	300	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	operating junction temperature		_	+150	°C

## Note

1. Device mounted on a printed-circuit board.



Philips Semiconductors Preliminary specification

## N-channel dual-gate MOS-FET

BF908WR

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	350	K/W
R <sub>th j-s</sub>	thermal resistance from junction to soldering point	$T_s = 87 ^{\circ}\text{C}$ ; note 2	210	K/W

#### Notes

- 1. Device mounted on a printed-circuit board.
- 2.  $T_{\mbox{\scriptsize S}}$  is the temperature at the soldering point of the source lead.

### STATIC CHARACTERISTICS

 $T_j = 25$  °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>(BR)G1-SS</sub>	gate 1-source breakdown voltage	$V_{G2-S} = V_{DS} = 0$ ; $I_{G1-S} = 10 \text{ mA}$	8	_	20	V
V <sub>(BR)G2-SS</sub>	gate 2-source breakdown voltage	$V_{G1-S} = V_{DS} = 0$ ; $I_{G2-S} = 10 \text{ mA}$	8	_	20	٧
V <sub>(P)G1-S</sub>	gate 1-source cut-off voltage	$V_{G2-S} = 4 \text{ V}; V_{DS} = 8 \text{ V}; I_D = 20 \mu\text{A}$	_	_	-2	٧
V <sub>(P)G2-S</sub>	gate 2-source cut-off voltage	$V_{G1-S} = 4 \text{ V}; V_{DS} = 8 \text{ V}; I_D = 20 \mu\text{A}$	_	_	-1.5	V
I <sub>DSS</sub>	drain-source current	$V_{G2-S} = 4 \text{ V}; V_{DS} = 8 \text{ V}; V_{G1-S} = 0$	3	15	27	mA
I <sub>G1-SS</sub>	gate 1 cut-off current	$V_{G2-S} = V_{DS} = 0; V_{G1-S} = 5 V$	_	_	50	nA
I <sub>G2-SS</sub>	gate 2 cut-off current	$V_{G1-S} = V_{DS} = 0; V_{G2-S} = 5 \text{ V}$	_	_	50	nA

### **DYNAMIC CHARACTERISTICS**

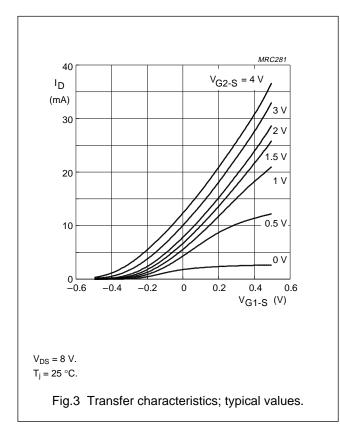
Common source;  $T_{amb}$  = 25 °C;  $V_{DS}$  = 8 V;  $V_{G2-S}$  = 4 V;  $I_D$  = 15 mA; unless otherwise specified.

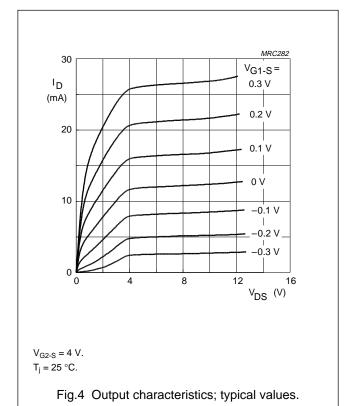
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
y <sub>fs</sub>	forward transfer admittance	pulsed; T <sub>j</sub> = 25 °C	36	43	50	mS
C <sub>ig1-s</sub>	input capacitance at gate 1	f = 1 MHz	2.4	3.1	4	pF
C <sub>ig2-s</sub>	input capacitance at gate 2	f = 1 MHz	1.2	1.8	2.5	pF
Cos	drain-source capacitance	f = 1 MHz	1.2	1.7	2.2	pF
C <sub>rs</sub>	reverse transfer capacitance	f = 1 MHz	20	30	45	fF
F	noise figure	$f = 200 \text{ MHz}$ ; $G_S = 2 \text{ mS}$ ; $B_S = B_{Sopt}$	_	0.6	1.2	dB
		$f = 800 \text{ MHz}; G_S = G_{Sopt}; B_S = B_{Sopt}$	_	1.5	2.5	dB

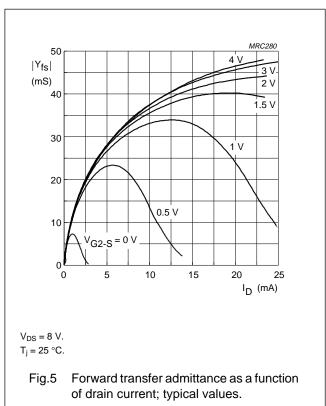
Philips Semiconductors Preliminary specification

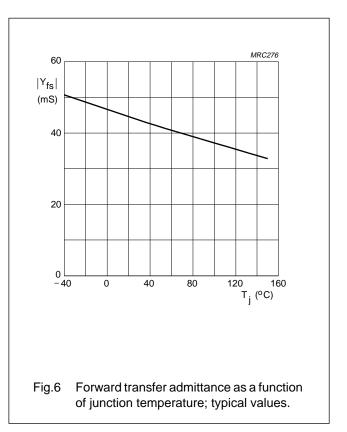
## N-channel dual-gate MOS-FET

## BF908WR









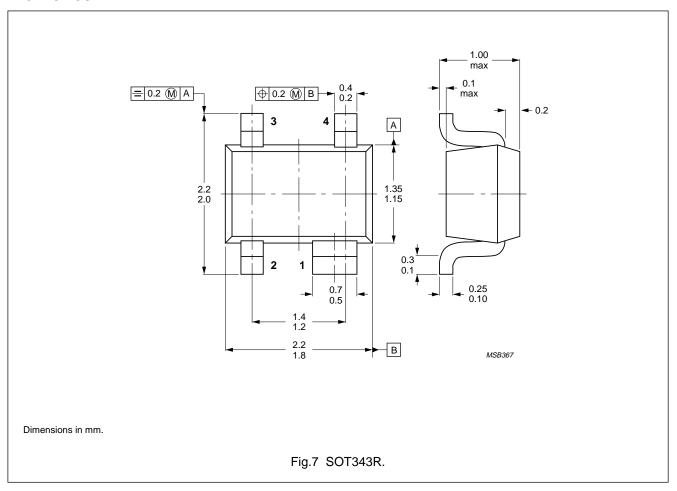
1995 Apr 25

5

## N-channel dual-gate MOS-FET

## BF908WR

## **PACKAGE OUTLINE**



Philips Semiconductors Preliminary specification

## N-channel dual-gate MOS-FET

BF908WR

#### **DEFINITIONS**

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.